

RoHS

COMPLIANT HALOGEN

FREE

CEM6188-VB Datasheet

Dual N-Channel 60-V (D-S) MOSFET

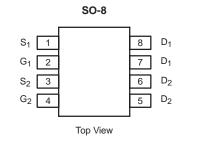
| PRODUCT SUMMARY | | | | | | |
|---------------------|----------------------------------|--------------------|-----------------------|--|--|--|
| V _{DS} (V) | R _{DS(on)} (Ω) | I _D (A) | Q _g (Typ.) | | | |
| 60 | 0.012 at V_{GS} = 10 V | 10 | 15 nC | | | |
| 60 | 0.015 at V _{GS} = 4.5 V | 9.0 | 15110 | | | |

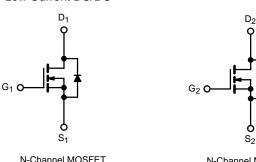
FEATURES

- Halogen-free According to IEC 61249-2-21 • Definition
- TrenchFET[®] Power MOSFET
- 100 % UIS Tested
- 100 % R_g Tested
- Compliant to RoHS Directive 2002/95/EC

APPLICATIONS

- Set Top Box
- Low Current DC/DC





N-Channel MOSFET

N-Channel MOSFET

| Parameter | Symbol | Limit | Unit | | |
|--|--|-----------------------------------|---------------------------|----|--|
| Drain-Source Voltage | | V _{DS} | 60 | V | |
| Gate-Source Voltage | | V _{GS} | ± 20 | v | |
| Continuous Drain Current (T _J = 150 °C) | T _C = 25 °C T _C = 70 °C | _ | 10 ^a 8.2 | | |
| | $T_{A} = 25 \text{ °C}$ | I _D | 7.2 ^{b, c} | | |
| Pulsed Drain Current | T _A = 70 °C | | 6.2 ^{b, c} 40 | Α | |
| | T _C = 25 °C | IDM | 2.25 | | |
| Continuous Source-Drain Diode Current | $T_{A} = 25 \text{ °C}$ | ا _S | 1.48 ^{b, c} | | |
| Single Pulse Avalanche Current | L = 0.1 mH | I _{AS} | 30 | | |
| L = 0.1 mH | | E _{AS} | 55 | mJ | |
| | T _C = 25 °C | | 2.7 | | |
| Maximum Power Dissipation | T _C = 70 °C | PD | 4.77 | w | |
| Maximum Power Dissipation | T _A = 25 °C | 'D | 2.78 ^{b, c} | vv | |
| | T _A = 70 °C | | 1.14 ^{b, c} | | |
| Operating Junction and Storage Temperature Range | | T _J , T _{stg} | - 55 to 150 | °C | |

| THERMAL RESISTANCE RATINGS | | | | | | | |
|--|--------------|-------------------|---------|------|-------|--|--|
| Parameter | Symbol | Typical | Maximum | Unit | | | |
| Maximum Junction-to-Ambient ^{a, c, d} | t ≤ 10 s | R _{thJA} | 58 | 70 | °C/W | | |
| Maximum Junction-to-Foot (Drain) | Steady State | R _{thJF} | 38 | 45 | - C/W | | |

Notes:

Г

a. Package limited, $T_C = 25 \text{ °C}$. b. Surface Mounted on 1" x 1" FR4 board.

d. Maximum under Steady State conditions is 110 °C/W.

服务热线:400-655-8788

c. t = 10 s.



| Parameter | Symbol | Test Conditions | Min. | Тур. | Max. | Unit | |
|---|-------------------------|---|------|-------|-------|-------|--|
| Static | | | | | | • | |
| Drain-Source Breakdown Voltage | V _{DS} | $V_{GS} = 0 \text{ V}, \text{ I}_{D} = 250 \mu\text{A}$ | 60 | | | V | |
| V _{DS} Temperature Coefficient | $\Delta V_{DS}/T_{J}$ | L _ 250 uA | | 32 | | mV/°C | |
| V _{GS(th)} Temperature Coefficient | $\Delta V_{GS(th)}/T_J$ | I _D = 250 μA | | - 5.0 | | | |
| Gate-Source Threshold Voltage | V _{GS(th)} | $V_{DS} = V_{GS}$, $I_D = 250 \ \mu A$ | 1.0 | | 2.5 | V | |
| Gate-Source Leakage | I _{GSS} | $V_{DS} = 0 V, V_{GS} = \pm 20 V$ | | | ± 100 | nA | |
| | I _{DSS} - | $V_{DS} = 30 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$ | | | 1 | μA | |
| Zero Gate Voltage Drain Current | | V _{DS} = 30 V, V _{GS} = 0 V, T _J = 55 °C | | | 10 | | |
| On-State Drain Current ^a | I _{D(on)} | $V_{DS} \ge 5$ V, V_{GS} = 10 V | 10 | | | Α | |
| | | V _{GS} = 10 V, I _D = 5 A | | 0.012 | | | |
| Drain-Source On-State Resistance ^a | R _{DS(on)} | V _{GS} = 4.5 V, I _D = 4 A | | 0.015 | | Ω | |
| Forward Transconductance ^a | g _{fs} | $V_{DS} = 10 \text{ V}, I_D = 5 \text{ A}$ | | 16 | | S | |
| Dynamic ^b | <u> </u> | | | | | | |
| Input Capacitance | C _{iss} | | | 586 | | pF | |
| Output Capacitance | C _{oss} | V _{DS} = 15 V, V _{GS} = 0 V, f = 1 MHz | | 217 | | | |
| Reverse Transfer Capacitance | C _{rss} | | | 155 | | | |
| Total Gate Charge | Q _g | $V_{DS} = 15 \text{ V}, V_{GS} = 10 \text{ V}, I_{D} = 5 \text{ A}$ | | 15 | 25 | nC | |
| | | | | 6.7 | 9.6 | | |
| Gate-Source Charge | Q _{gs} | V_{DS} = 15 V, V_{GS} = 4.5 V, I_{D} = 5 A | | 4.4 | 6.0 | | |
| Gate-Drain Charge | Q _{gd} | | | 3.05 | 4.0 | | |
| Gate Resistance | R _g | f = 1 MHz | 0.8 | 4.3 | 8.6 | Ω | |
| Turn-On Delay Time | t _{d(on)} | | | 12 | 24 | ns | |
| Rise Time | t _r | V_{DD} = 15 V, R_L = 3 Ω | | 55 | 100 | | |
| Turn-Off Delay Time | t _{d(off)} | $\text{I}_\text{D} \cong \text{5}$ A, V_GEN = 4.5 V, R_g = 1 Ω | | 11 | 22 | | |
| Fall Time | t _f | | | 8 | 16 | | |
| Turn-On Delay Time | t _{d(on)} | | | 4 | 8 | | |
| Rise Time | t _r | V_{DD} = 15 V, R_L = 3 Ω | | 9 | 18 | | |
| Turn-Off Delay Time | t _{d(off)} | $I_D \cong 5$ A, V_{GEN} = 10 V, R_g = 1 Ω | | 10 | 20 | | |
| Fall Time | t _f | | | 6 | 12 | | |
| Drain-Source Body Diode Characteristi | cs | | | | | | |
| Continuous Source-Drain Diode Current | ۱ _S | T _C = 25 °C | | | 2.25 | | |
| Pulse Diode Forward Current | I _{SM} | | | | 24 | A | |
| Body Diode Voltage | V _{SD} | $I_{S} = 2 \text{ A}, V_{GS} = 0 \text{ V}$ | | 0.8 | 1.2 | V | |
| Body Diode Reverse Recovery Time | t _{rr} | | | 11 | 20 | ns | |
| Body Diode Reverse Recovery Charge | Q _{rr} | | | 4 | 8 | nC | |
| Reverse Recovery Fall Time | ta | $I_F = 5 \text{ A}, \text{ dI/dt} = 100 \text{ A/}\mu\text{s}, \text{ T}_J = 25 ^\circ\text{C}$ | | 7 | | | |
| Reverse Recovery Rise Time | t _b | | | 4 | | ns | |

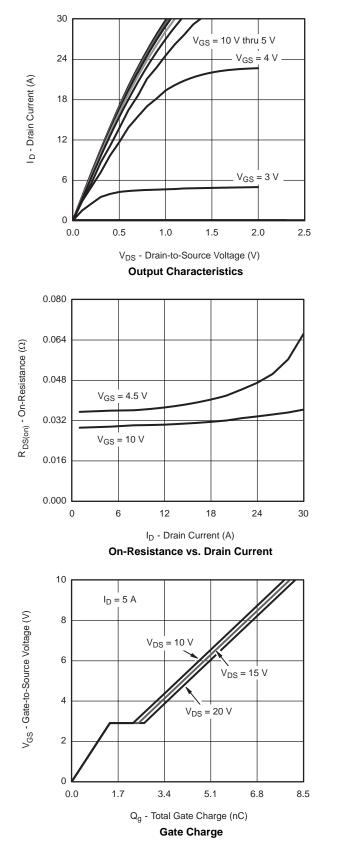
Notes:

a. Pulse test; pulse width \leq 300 µs, duty cycle \leq 2 %

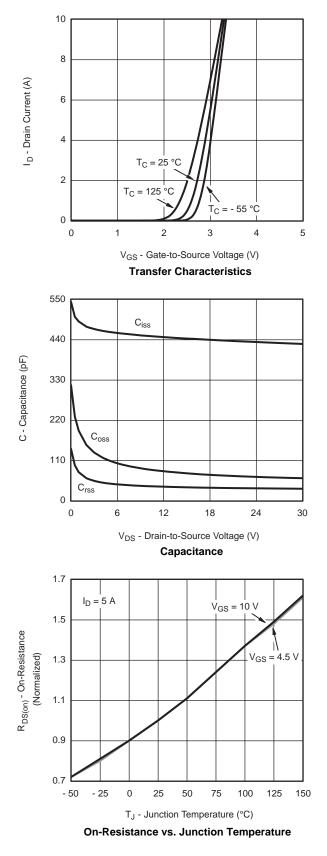
b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

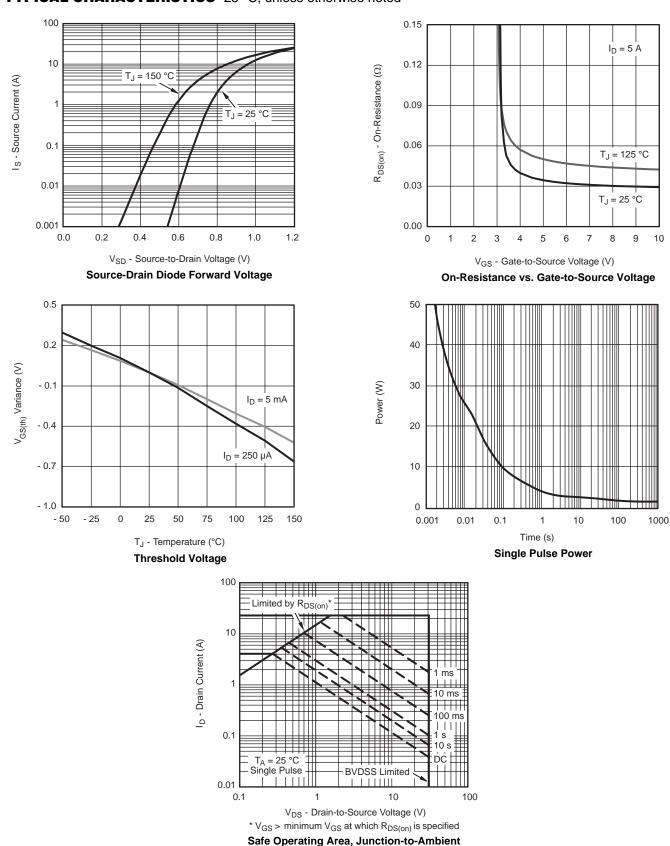




TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



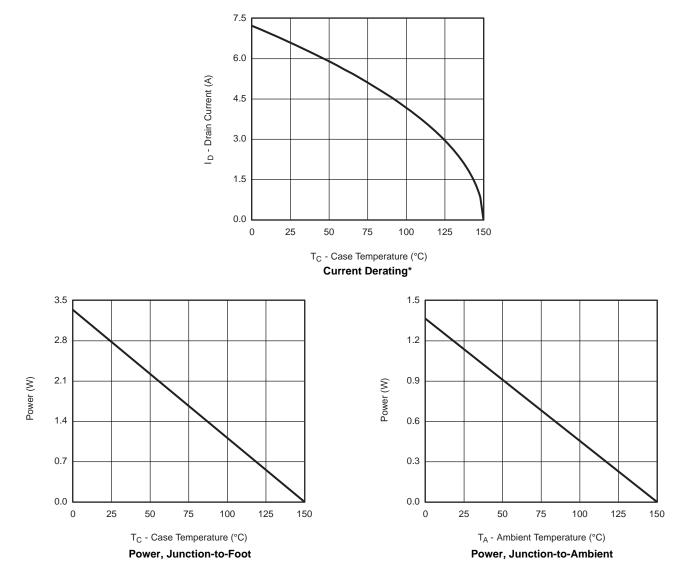




TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



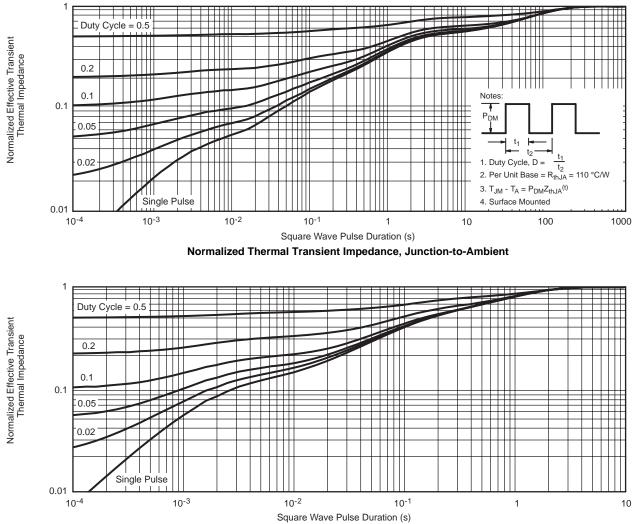
TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



* The power dissipation P_D is based on $T_{J(max)} = 150$ °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.







Normalized Thermal Transient Impedance, Junction-to-Foot



SOIC (NARROW): 8-LEAD JEDEC Part Number: MS-012

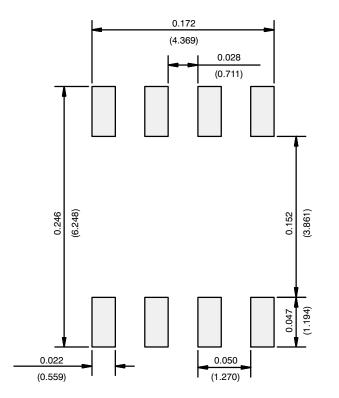




| | MILLIMETERS | | INC | HES | | |
|---|-------------|------|--------|-----------|--|--|
| DIM | Min | Мах | Min | Max | | |
| A | 1.35 | 1.75 | 0.053 | 0.069 | | |
| A ₁ | 0.10 | 0.20 | 0.004 | 0.008 | | |
| В | 0.35 | 0.51 | 0.014 | 0.020 | | |
| С | 0.19 | 0.25 | 0.0075 | 0.010 | | |
| D | 4.80 | 5.00 | 0.189 | 0.196 | | |
| E | 3.80 | 4.00 | 0.150 | 0.157 | | |
| е | 1.27 | BSC | 0.050 | 0.050 BSC | | |
| Н | 5.80 | 6.20 | 0.228 | 0.244 | | |
| h | 0.25 | 0.50 | 0.010 | 0.020 | | |
| L | 0.50 | 0.93 | 0.020 | 0.037 | | |
| q | 0° | 8° | 0° | 8° | | |
| S | 0.44 | 0.64 | 0.018 | 0.026 | | |
| ECN: C-06527-Rev. I, 11-Sep-06 DWG: 5498 | | | | | | |



RECOMMENDED MINIMUM PADS FOR SO-8



Recommended Minimum Pads Dimensions in Inches/(mm)

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